

Weidmüller Interface GmbH & Co. KG

Klingenbergstraße 26 D-32758 Detmold Germany

www.weidmueller.com

Product image

















High-temperature-resistant pin header, packed in box or tape. On tape, with 1.5 mm solder pin, optimised for automatic assembly. 3.2 mm solder pin suitable for reflow and wave soldering. The pin headers provide space for labelling and can be coded. HC = High Current.

General ordering data

| Version | PCB plug-in connector, male header, Solder flange, THT/THR solder connection, 5.00 mm, Number of poles: 5, 90°, Solder pin length (I): 1.5 mm, Gold- plated, black, Box |
|--------------|--|
| Order No. | <u>1177420000</u> |
| Туре | SL-SMT 5.00HC/05/90LF 1.5AU BK BX |
| GTIN (EAN) | 4032248971152 |
| Qty. | 48 pc(s). |
| Product data | IEC: / 27.5 A |
| | UL: / 18.5 A |
| Packaging | Box |

Creation date March 23, 2021 7:45:19 AM CET



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Technical data

| Dim | ensions | and | weights |
|-----|---------|-----|---------|
| | CHSIUHS | anu | WEIGHLS |

| Depth | 12 mm | Depth (inches) | 0.472 inch |
|--------------------------|---------|-----------------|------------|
| Height | 10 mm | Height (inches) | 0.394 inch |
| Height of lowest version | 8.5 mm | Net weight | 3.167 g |
| Width | 34.8 mm | Width (inches) | 1.37 inch |

System specifications

| Product family | OMNIMATE Signal - series BL/SL 5.00 | Type of connection | Board connection |
|-------------------------------------|--|---------------------------|-----------------------|
| Mounting onto the PCB | THT/THR solder connection | Pitch in mm (P) | 5 mm |
| Pitch in inches (P) | 0.197 inch | Outgoing elbow | 90° |
| Number of poles | 5 | Solder pin length (I) | 1.5 mm |
| Solder pin length tolerance | +0.1 / -0.2 mm | Solder pin dimensions | d = 1.2 mm, Octagonal |
| Solder pin dimensions = d tolerance | 0 / -0,03 mm | L1 in mm | 20 mm |
| L1 in inches | 0.787 inch | Pin series quantity | 1 |
| Volume resistance | ≤5 mΩ | Plugging force/pole, max. | 7 N |
| Pulling force/pole, max. | 5.5 N | | |

Material data

| Insulating material | LCP GF | Colour | black |
|---------------------------------------|-----------------------------|---------------------------------------|---------------------------------------|
| Colour chart (similar) | RAL 9011 | Insulating material group | Illa |
| Comparative Tracking Index (CTI) | ≥ 175 | Moisture Level (MSL) | 1 |
| Contact material | CuMg | Contact surface | Gold-plated |
| Layer structure of solder connection | 13 µm Ni / 24 µm Sn matt | Layer structure of plug contact | 13 µm Ni / 24 µm Sn / 1.72.3 µm Au |
| Storage temperature, min. | -40 °C | Storage temperature, max. | 70 °C |
| Operating temperature, min. | -50 °C | Operating temperature, max. | 100 °C |
| Temperature range, installation, min. | -30 °C | Temperature range, installation, max. | 100 °C |

Rated data acc. to IEC

| tested acc. to standard | | Rated current, min. number of poles | |
|-------------------------------------|------------------------|-------------------------------------|--------|
| | IEC 60664-1, IEC 61984 | (Tu=20°C) | 27.5 A |
| Rated current, max. number of poles | | Rated current, min. number of poles | |
| (Tu=20°C) | 19 A | (Tu=40°C) | 24 A |
| Rated current, max. number of poles | | | |
| (Tu=40°C) | 16.5 A | | |

Rated data acc. to CSA

Institute (UR)

| Rated current (Use group B / CSA) | 15 A | Rated current (Use group D / CSA) | 15 A |
|-----------------------------------|------|-----------------------------------|------|

Rated data acc. to UL 1059

Rated current (Use group B / UL 1059)

Reference to approval values

Specifications are maximum values, details -

Certificate No. (UR)

18.5 A

see approval certificate.



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Technical data

Packing

UL File Number Search

| i doking | | | |
|-----------------|--|--|---|
| | | | |
| Packaging | Вох | VPE length | 40 mm |
| VPE width | 70 mm | VPE height | 160 mm |
| Classifications | | | |
| ETIM 6.0 | EC002637 | ETIM 7.0 | EC002637 |
| ECLASS 9.0 | 27-44-04-02 | ECLASS 9.1 | 27-44-04-02 |
| ECLASS 10.0 | 27-44-04-02 | ECLASS 11.0 | 27-46-02-01 |
| Important note | | | |
| IPC conformity | standards and norms an | s are developed, manufactured and delived d comply with the assured properties in t A-610 "Class 2". Further claims on the pro | he data sheet resp. fulfill decorative properties |
| Notes | Long term storage of the product with average temperature of 50 °C and average humidity 70%, 36 months | | |
| Approvals | | | |
| Approvals | III S | Y . | |
| ROHS | Conform | | |

Conform E60693



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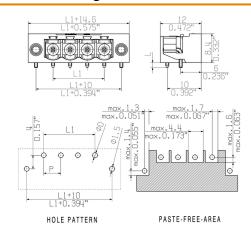
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Drawings

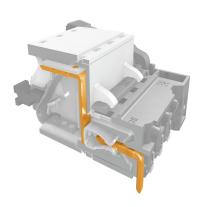
Product image



Dimensional drawing



Product benefits



Safe power transmission Proven properties



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Drawings

Product benefits





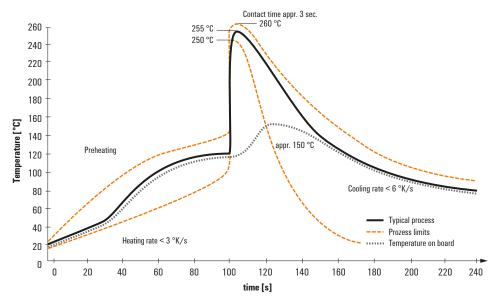
Recommended wave solderding profiles

Weidmüller Interface GmbH & Co. KG

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Fon: +49 5231 14-0 Fax: +49 5231 14-292083 www.weidmueller.com

Single Wave:



Double Wave:



Wave soldering profiles

Wired connection elements should be processed in accordance with the DIN EN 61760-1 standard. We have included two recommendations for practical wave soldering profiles, with which Weidmüller PCB terminals and connectors are qualified.

When choosing a suitable profile for your application, the following factors also need to be considered:

- PCB thickness
- Proportion of Cu in the layers
- Single/double-sided assembly
- Product range
- Heating and cooling rates

The single and double wave profiles each indicate the recommended operating range, including the maximum soldering temperature of 260°C. In practice, the maximum soldering temperature is quite often well below the above maximum profile.

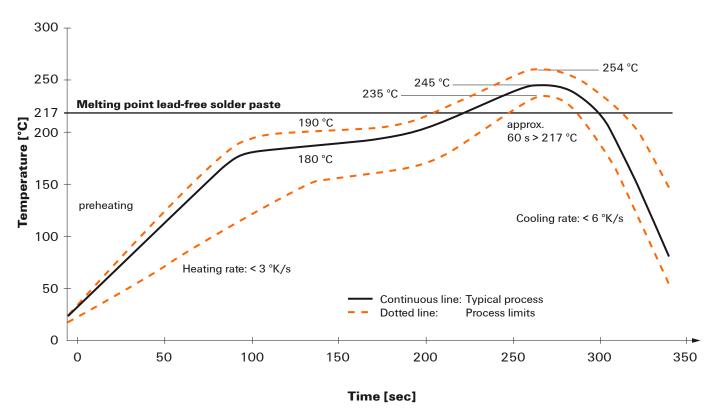


Recommended reflow soldering profile

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Reflow soldering profile

The perfect soldering profile for SMT Surface Mount Technology is one the most exiting question in SMT production. But there are more than one correct answer: The diagram of temperature-on-time is related to processing features of solder paste and to maximum load of components.

We have to consider the following parameters:

- · Time for pre heating
- Maximum temperature
- Time above melting point
- Time for cooling
- · Maximum heating rate
- Maximum cooling rate

We recommend a typical solder profile with associated process limits. With preheating components and board are prepared smoothly for the solder phase. Heating rate is typically $\leq +3$ K/s. In parallel the solder paste is ,activated'. The time above melting point of 217°C the paste gets liquid and components and boards begin to connect. The maximum temperature of 245°C to 254°C should stay between 10 and 40 seconds. In the cooling phase at \geq -6K/s solder is cured. Board and components cool down while avoiding cold cracks.